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OCT 25 2004

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Applicant Andrew Marshall

Docket Number: TI-31484

Serial No.: 10/007,332

Art Unit: 2815

Filed: 11/08/01

Examiner: Matthew E. Warren

For: Thermal Coupling of Matched SOI Device Bodies

CERTIFICATION OF FACSIMILE TRANSMISSION

I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office on the date shown below:

Karen Vertz
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10-25-04
Date

FACSIMILE COVER SHEET

<input checked="" type="checkbox"/> FACSIMILE COVER SHEET		<input type="checkbox"/> AMENDMENT (# Pages)
<input type="checkbox"/> NEW APPLICATION		<input type="checkbox"/> EOT
<input type="checkbox"/> DECLARATION		<input type="checkbox"/> NOTICE OF APPEAL
<input type="checkbox"/> ASSIGNMENT		<input type="checkbox"/> PARTIAL PAYMENT (# Pages)
<input type="checkbox"/> FORMAL DRAWINGS		<input type="checkbox"/> ISSUE FEE & PUBLICATION FEE (1 Page)
<input type="checkbox"/> INFORMAL DRAWINGS		<input type="checkbox"/> REPLY BRIEF (IN TRIPPLICATE) (# Pages)
<input type="checkbox"/> CONTINUATION APPN		<input type="checkbox"/> ELECTION
<input type="checkbox"/> DIVISIONAL APPN		
NAME OF INVENTOR(S): Andrew Marshall		
TITLE OF INVENTION: Thermal Coupling of Matched SOI Device Bodies		
TI FILE NO.:	DEPOSIT ACCT. NO.:	RECEIPT DATE & SERIAL NO.:
TI-31484	20-0668	Serial No.: 10/007,332 Filing Date: 11/08/01
FAXED: 10-25-04 DUE: 10-26-04 ATTY/SECY: RAK/kjv		

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Dallas, TX 75265-5474

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Serial No.: 10/007,332

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NOTICE OF APPEAL FROM THE PRIMARY EXAMINER TO THE BOARD OF APPEALS

CERTIFICATION OF FAXIMILE TRANSMISSION
I hereby certify that the above correspondence is being transmitted by facsimile to the U.S. Patent and Trademark Office at 703-872-9306 on the date shown below:

Karen Vertz
Karen Vertz

10-25-04

Date

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Applicant hereby appeals claims 6-13 and 15-19 to the Board of Appeals from the decision dated July 26, 2004 of the Primary Examiner finally rejecting claims 6-13 and 15-19.

The item(s) checked below are appropriate:

1. An extension of time to respond to the final rejection
 was granted on _____.
 is requested for ____ month(s).
2. A timely response to the final rejection has been filed, as provided in 841 O.G. 1411.
3. Fee \$340.00:
 Not required (Fee paid in prior appeal)
 The Commissioner of Patents is hereby authorized to charge any fees which may be required, or credit any overpayment to Deposit Account No. 20-0668 of Texas Instruments Incorporated.

Signature [Rule 191(b)]

Post Office Address (to which correspondence is to be sent)
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